



NPN Switching Transistor



SOT-89

MPSA44U

Surface mount Plastic Package RoHS compliant

SOT-89

FEATURES:

- 1. Collector-Emitter voltage: V_{CEO}=400V
- 2. Collector current up to 300mA
- 3. Complement to MPSA94
- 4. This product is available in AEC-Q101 Compliant and PPAP Capable also.

Note: For AEC-Q101 compliant products, please use suffix -AQ in the part number while ordering.

APPLICATIONS:

- 1.Telephone switching
- 2.High voltage switch

ABSOLUTE MAXIMUM RATINGS ($T_a = 25 \circ C$)

Parameter	Symbol	Value	Unit	
Collector Base Voltage		V _{CBO}	500	
Collector Emitter Voltage	V_{CEO}	400	V	
Emitter Base Voltage	V_{EBO}	6		
Collector Current		I _C	300	mA
Collector Power Dissipation	р	625	mW	
Collector Fower Dissipation	Tc = 25°C	Pc	1.5	W
Junction Temperature		Tj	+150	°C
Storage Temperature		T _{stg}	-55 ~ +150	°C





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ELECTRICAL CHARACTERISTICS at Ta = 25 $_{\circ}C$

Baramatar	Symbol Test Conditions			UNIT			
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	5111	
Collector-base breakdown voltage	V _{(BR)CBO}	Ι _C =100μΑ,Ι _Ε =0	500				
Collector-emitter breakdown voltage	V _{(BR)CEO}	I _C =1mA, I _B =0	400	-		V	
Emitter-base breakdown voltage	$V_{(BR)EBO}$	I _E = 100μA, I _C = 0	6	-			
Collector cut-off current	I _{CBO}	$V_{CB} = 400 V, I_{E} = 0$	-		100		
Collector cut-off current	I _{CES}	$V_{CB} = 400 V, I_{E} = 0$	-		500	nA	
Emitter cut-off current	I _{EBO}	$V_{CB} = 400V, I_{C} = 0$	-		100		
	$h_{FE(1)}$	V _{CE} = 10V, I _C = 1mA	40				
DC ourrent agin	$h_{FE(2)}$	V_{CE} = 10V, I_{C} = 10mA	50		240		
DC current gain	$h_{FE(3)}$	V _{CE} = 10V, I _C = 50mA	45				
	$h_{FE(4)}$	V _{CE} = 10V, I _C =100mA	40				
		$I_{\rm C} = 1$ mA, $I_{\rm B} = 0.1$ mA	-		0.4		
Collector-emitter saturation voltage	V _{CE(sat)}	I _C = 1mA,I _B = 0.1mA			0.5	V	
		I _C = 50mA,I _B = 5mA			0.75	v	
Base-emitter saturation voltage	V _{BE(sat)}	I _C = 10mA,I _B =1mA			0.75		
Transition frequency	f _⊤	V _{CE} =20V, I _C =10mA,	50			MHz	
Output capacitance	C _{ob}	$V_{CB} = 20V, I_E = 0,$			7	pF	

THERMAL RESISTANCE

Description	Symbol	Value	Unit
Junction to Case	$R_{th(J-C)}$	83.33	°C/W
Junction to Ambient	$R_{th(J-A)}$	200	°C/W

Notes:

1.Pulse test: PW<300µs,Duty Cycle<2%



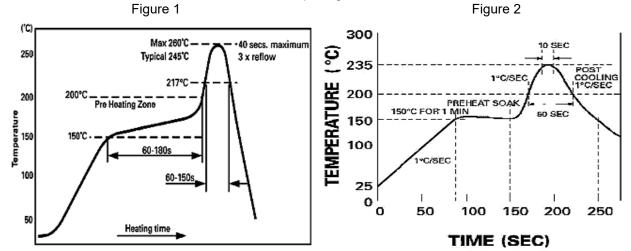


Recommended Reflow Solder Profiles

The recommended reflow solder profiles for Pb and Pb-free devices are shown below.

Figure 1 shows the recommended solder profile for devices that have Pb-free terminal plating, and where a Pb-free solder is used.

Figure 2 shows the recommended solder profile for devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with a leaded solder.

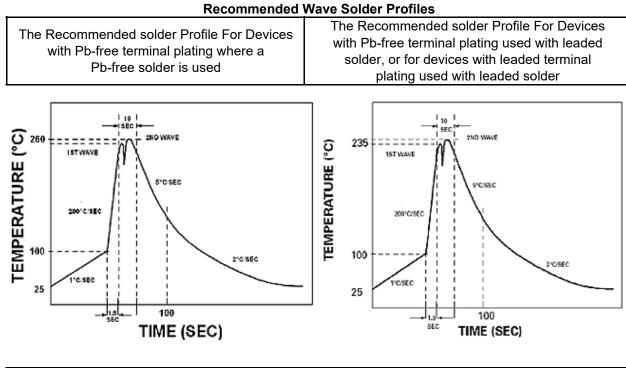


Reflow profiles in tabular form							
Profile Feature	Sn-Pb System	Pb-Free System					
Average Ramp-Up Rate	~3°C/second	~3°C/second					
Preheat							
 Temperature Range 	150-170°C	150-200°C					
– Time	60-180 seconds	60-180 seconds					
Time maintained above:							
– Temperature	200°C	217°C					
– Time	30-50 seconds	60-150 seconds					
Peak Temperature	235°C	260°C max.					
Time within +0 -5°C of actual Peak	10 seconds	40 seconds					
Ramp-Down Rate	3°C/second max.	6°C/second max.					





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Wave Profiles in Tabular Form								
Profile Feature	Sn-Pb System	Pb-Free System						
Average Ramp-Up Rate	~200°C/second	~200°C/second						
Heating rate during preheat	Typical 1-2, Max 4°C/sec	Typical 1-2, Max 4°C/Sec						
Final preheat Temperature	Within 125°C of Solder Temp	Within 125°C of Solder Tem						
Peak Temperature	235°C	260°C max.						
Time within +0 -5°C of actual Peak	10 seconds	10 seconds						
Ramp-Down Rate	5°C/second max.	5°C/second max						

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Typical Characteristic curves

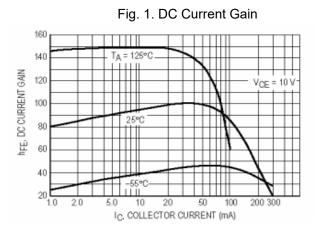


Fig. 2. Collector Saturation Region

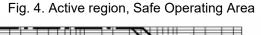
= 50 mA

TΔ

10 k

50 k

le



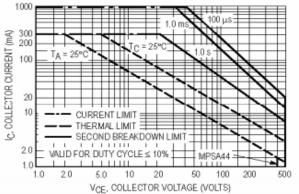


Fig. 5. Capacitance

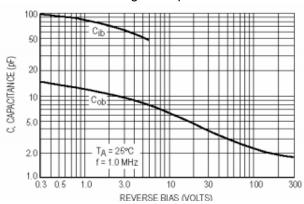
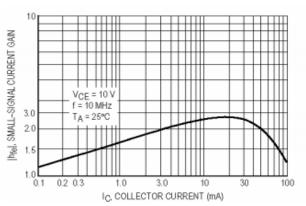
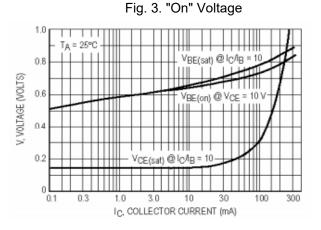


Fig. 6. High frequency Current Gain





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VCE. COLLECTOR-EMITTER VOLTAGE (VOLTS)

0.5

0.4

0.3

0.2

0.1

Ũ

10

30

100

300

1.0 k

IB, BASE CURRENT (µA)

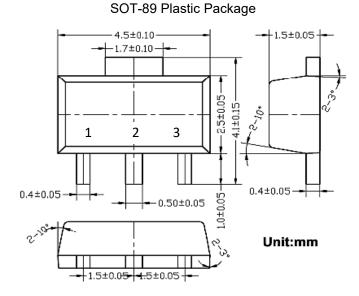
3.0 k

0 m/





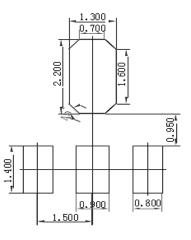
Package Details



Pin Configuration

- 1. Base
- 2. Collector
- 3. Emitter

SOT-89 Suggested Pad Layout



Note:

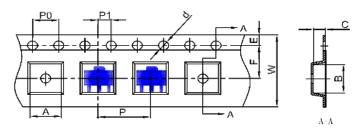
- 1. Controlling Dimension:in millimeters.
- 2. General tolerance:±0.05mm
- 3. The pad Layout is for reference purposes only.





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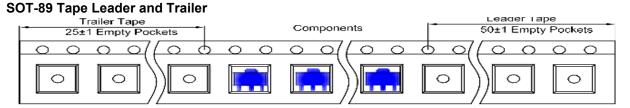
SOT-89 Tape and Reel SOT-89 Embossed Carrier Tape



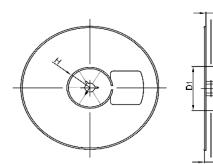
Packaging Description:

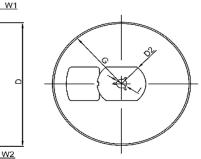
SOT-89 Parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer,sealant, and anti-Static sprayed agent. these reeled parts in standard option are shipped with 3000 units per 7" or 17.8cm diameter reel. The reels are clear in color and is made of polystyrene plastic (antistatic coated).

Dimensions are in millimeter										
Pkgtype A B U d E F P0 P P1 W										
SOT-89-3L	4.85	4.45	1.80	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00



SOT - 89 Reel





Dimensions are in millimeter										
Reel Option	D	C)1	D2	G	Н		I	W1	W2
7"Dia	Ø180.00	60.	.00	R32.00	R86.50	R30.00	Ø	13.00	13.20	16.50
REEL	Reel Si	ze	ł	зох	Box Size(mm)	Carton		Carton S	Size(mm)	G.W.(kg)
1000 pcs	7 incl	n	10,0	00 pcs	203×203×195	40,000 pe	CS	438×4	38×220	

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Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- Temperature 5 °C to 30 °C
- Humidity between 40 to 70 %RH
- · Air should be clean.
- · Avoid harmful gas or dust.
- · Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- · Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- · Avoid rapid change of temperature.
- · Avoid condensation.
- · Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- \cdot The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start. For this, the following JEDEC table may be referred:

JEDEC MSL Level							
Level	Level Time						
1	Unlimited	≤30 °C / 85% RH					
2	1 Year	≤30 °C / 60% RH					
2a	4 Weeks	≤30 °C / 60% RH					
3	168 Hours	≤30 °C / 60% RH					
4	72 Hours	≤30 °C / 60% RH					
5	48 Hours	≤30 °C / 60% RH					
5a	24 Hours	≤30 °C / 60% RH					
6	Time on Label(TOL)	≤30 °C / 60% RH					





Customer Notes

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s). CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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